

# NSR10F30NXT5G

## Schottky Barrier Diode

These Schottky barrier diodes are optimized for low forward voltage drop and low leakage current and are offered in a Chip Scale Package (CSP) to reduce board space. The low thermal resistance enables designers to meet the challenging task of achieving higher efficiency and meeting reduced space requirements.

### Features

- Low Forward Voltage Drop – 420 mV @ 1.0 A
- Low Reverse Current – 20  $\mu$ A @ 10 V VR
- 1.0 A of Continuous Forward Current
- ESD Rating – Human Body Model: Class 3B  
– Machine Model: Class C
- High Switching Speed
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

### Typical Applications

- LCD and Keypad Backlighting
- Camera Photo Flash
- Buck and Boost dc-dc Converters
- Reverse Voltage and Current Protection
- Clamping & Protection

### Markets

- Mobile Handsets
- MP3 Players
- Digital Camera and Camcorders
- Notebook PCs & PDAs
- GPS

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Reverse Voltage	$V_R$	30	V
Forward Current (DC)	$I_F$	1.0	A
Forward Surge Current (60 Hz @ 1 cycle)	$I_{FSM}$	18	A
ESD Rating:			
Human Body Model	ESD	> 8	kV
Machine Model		> 400	V

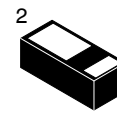
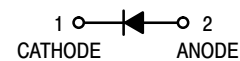
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



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<http://onsemi.com>

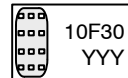
## 30 V SCHOTTKY BARRIER DIODE



**DSN2  
(0502)  
CASE 152AD**

### MARKING DIAGRAM

PIN 1



10F30 = Specific Device Code  
YYY = Year Code

### ORDERING INFORMATION

Device	Package	Shipping†
NSR10F30NXT5G	DSN2 (Pb-Free)	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# NSR10F30NXT5G

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Min	Typ	Max	Unit
Thermal Resistance Junction-to-Ambient (Note 1) Total Power Dissipation @ $T_A = 25^\circ\text{C}$	$R_{\theta JA}$ $P_D$			228 548	$^\circ\text{C}/\text{W}$ mW
Thermal Resistance Junction-to-Ambient (Note 2) Total Power Dissipation @ $T_A = 25^\circ\text{C}$	$R_{\theta JA}$ $P_D$			85 1.47	$^\circ\text{C}/\text{W}$ W
Storage Temperature Range	$T_{stg}$			-40 to +125	$^\circ\text{C}$
Junction Temperature	$T_J$			+150	$^\circ\text{C}$

- Mounted onto a 4 in square FR-4 board 50 mm sq. 1 oz. Cu 0.06" thick single sided. Operating to steady state.
- Mounted onto a 4 in square FR-4 board 1 in sq. 1 oz. Cu 0.06" thick single sided. Operating to steady state.

## ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
Reverse Leakage ( $V_R = 10\text{ V}$ ) ( $V_R = 30\text{ V}$ )	$I_R$			20 100	$\mu\text{A}$
Forward Voltage ( $I_F = 0.5\text{ A}$ ) ( $I_F = 1.0\text{ A}$ )	$V_F$		0.400 0.450	0.420 0.470	V

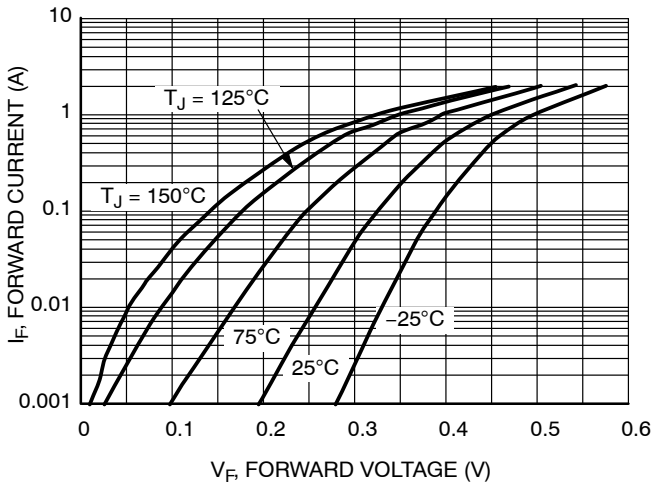


Figure 1. Forward Voltage

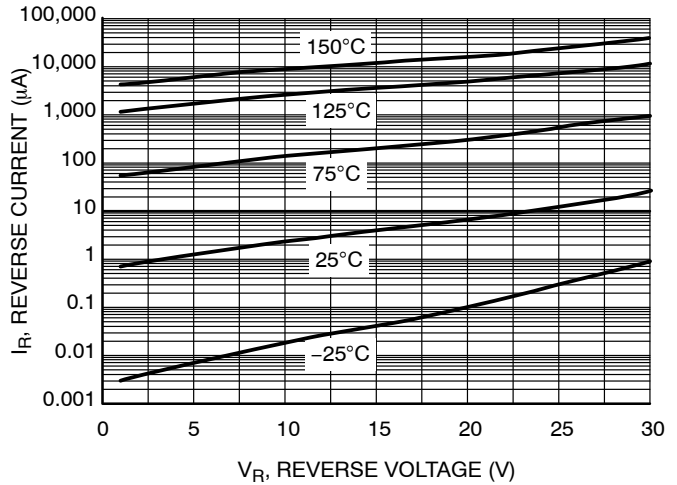


Figure 2. Typical Reverse Current

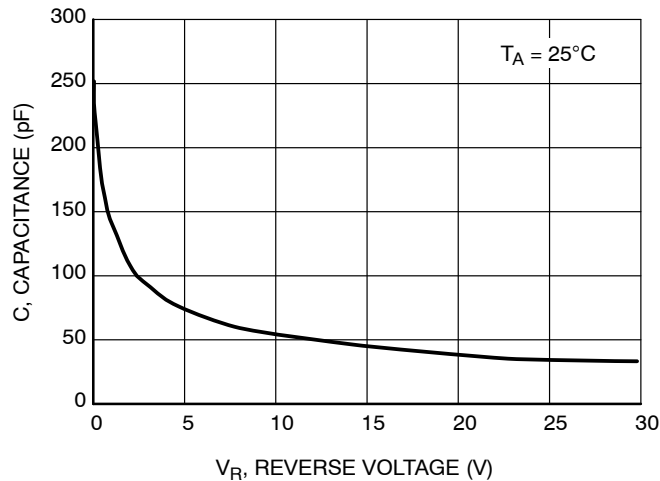
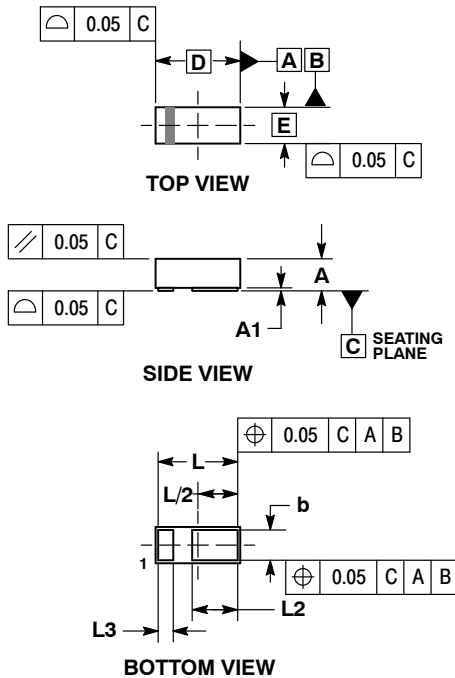


Figure 3. Typical Capacitance

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## PACKAGE DIMENSIONS

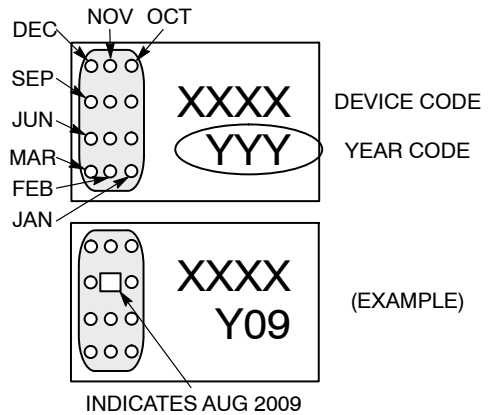
DSN2, 1.4x0.6, 0.75P  
CASE 152AD-01  
ISSUE A



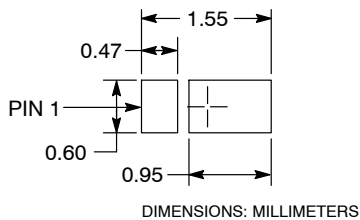
- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.

MILLIMETERS		
DIM	MIN	MAX
A	0.25	0.31
A1	---	0.05
b	0.45	0.55
D	1.40 BSC	
E	0.60 BSC	
L	1.20	1.30
L2	0.70	0.80
L3	0.20	0.30

### CATHODE BAND MONTH CODING



### MOUNTING FOOTPRINT\*



See Application Note AND8398/D for more mounting details

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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